



**Notification# 20200210003**  
**Datasheet for BQ33100**  
**Information Only**

**Date:** May 18, 2020

Dear Customer:

This is an information-only announcement of a change to the datasheet for a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN team ([PCN\\_ww\\_admin\\_team@list.ti.com](mailto:PCN_ww_admin_team@list.ti.com)).

Sincerely,

PCN Team  
SC Business Services


**Information Only  
Attachments**

**Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

<b>DEVICE</b>	<b>CUSTOMER PART NUMBER</b>
BQ33100PWR	39070151

Technical details of this Product Change follow on the next page(s).

<b>PCN Number:</b>	20200210003		<b>PCN Date:</b>	May 18, 2020	
<b>Title:</b>	Datasheet for BQ33100				
<b>Customer Contact:</b>	PCN Manager			<b>Dept:</b>	Quality Services
<b>Change Type:</b>					
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design	<input type="checkbox"/>	Wafer Bump Site
<input type="checkbox"/>	Assembly Process	<input checked="" type="checkbox"/>	Data Sheet	<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change	<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site	<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process	<input type="checkbox"/>	Wafer Fab Materials
		<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process
<b>Notification Details</b>					
<b>Description of Change:</b>					
<p>Texas Instruments Incorporated is announcing an information only notification.  The product datasheet(s) is being updated as summarized below.  The following change history provides further details.</p>					
 <p><b>Changes from Revision B (December 2015) to Revision C</b></p>					
<ul style="list-style-type: none"> <li>Changed <i>Recommended Operating Conditions</i> .....</li> <li>Changed <i>OC Dsg</i> .....</li> <li>Changed <i>OC Dsg Time</i> .....</li> <li>Changed <i>SC Dsg Cfg</i> .....</li> <li>Changed <i>SC Chg Cfg</i> .....</li> <li>Changed <i>Initial 1st Capacitance</i> .....</li> <li>Changed <i>Capacitance</i> .....</li> <li>Changed <i>Measurement Margin %</i> .....</li> <li>Changed <i>Max Dsg Time</i> .....</li> <li>Changed <i>V Chg Nominal</i> .....</li> </ul>					
The datasheet number will be changing.					
Device Family		Change From:		Change To:	
BQ33100		SLUS987B		SLUS987C	
<b>Reason for Change:</b>					
To accurately reflect device characteristics.					
<b>Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):</b>					
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.					
<b>Changes to product identification resulting from this PCN:</b>					
None.					
<b>Product Affected:</b>					
BQ33100PW		BQ33100PWR			

For questions regarding this notice, e-mails can be sent to the regional contacts shown below, or you can contact your local Field Sales Representative.

Location	E-Mail
USA	<a href="mailto:PCNAmericasContact@list.ti.com">PCNAmericasContact@list.ti.com</a>
Europe	<a href="mailto:PCNEuropeContact@list.ti.com">PCNEuropeContact@list.ti.com</a>
Asia Pacific	<a href="mailto:PCNAsiaContact@list.ti.com">PCNAsiaContact@list.ti.com</a>
WW PCN Team	<a href="mailto:PCN_ww_admin_team@list.ti.com">PCN_ww_admin_team@list.ti.com</a>

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